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#### PATENT

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants:

Toshiharu DAII, et al.

Serial No.:

10/774,529

Group Art Unit: 2818

Filed:

February 10, 2004

Examiner: Chuong A. Luu

For:

SEMICONDUCTOR WAFER PROCESSING METHOD

# SECOND INFORMATION DISCLOSURE STATEMENT

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

Pursuant to the duty of disclosure under 37 C.F.R. 1.56, Applicants are enclosing an Information Disclosure Citation Form (PTO-1449) which lists the references cited in the attached Australian Patent Office Search Report. Copies of the references are also enclosed.

Each item of information contained in this Information Disclosure Statement was cited in a communication from a foreign patent office in a counterpart foreign application not more than three months prior to the filing of this Information Disclosure Statement.

It is respectfully requested that the cited documents be considered by the Examiner in the above-identified patent application and that the cited documents be made officially of record therein. It is further requested that a listing of the same appear on the face of any patent which may issue from this application.

Respectfully submitted,

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Date: January 25, 2006

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INFORMATION CERCLOSHEE STATEMENT	ATTY. DOCKET 033773 M 064	SERIAL NO. 10/774,529		
- a m	APPLICANT:  Toshiharu DAII, et al.			
	FILING DATE February 10, 2004	GROUP ART UNIT 2818		

#### **U.S. PATENT DOCUMENTS**

U.S. PATENT DOCUMENTS									
*Examiner's Initials		DOCUMENT NUMBER	DATE	NAME	CLASS	SUB- CLASS	FILING DATE, IF APPROPRIATE		
	AA	20020031863	March 14, 2002	Nakata et al.					
	AB	6,511,895	January 28, 2003	Koma et al.					
	AC								
	AD								
	AE								
	AF								
	AG								

### FOREIGN PATENT DOCUMENTS

*Examiner's DOCUMENT DATE COUNTRY CLASS SUB- TRANSLATION									
	DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUB- CLASS	TRANSLA YES	TION NO		
АН	2003-007648	1/10/2003	Japan			X			
Al	2002-353170	12/6/2002	Japan			abstract			
AJ	WO 02/51217	6/27/2002	wo						
AK	0 981 156	7/14/2004	EP						
AL						-			
АМ						·			
AN									
AO									
	AI AJ AK AL AM	NUMBER AH 2003-007648 AI 2002-353170 AJ WO 02/51217 AK 0 981 156 AL AM AN	DOCUMENT NUMBER AH 2003-007648 1/10/2003 AI 2002-353170 12/6/2002 AJ WO 02/51217 6/27/2002 AK 0 981 156 7/14/2004 AL AM AN	DOCUMENT NUMBER         DATE         COUNTRY           AH 2003-007648         1/10/2003         Japan           AI 2002-353170         12/6/2002         Japan           AJ WO 02/51217         6/27/2002         WO           AK 0 981 156         7/14/2004         EP           AL         AM	DOCUMENT NUMBER         DATE         COUNTRY         CLASS           AH 2003-007648         1/10/2003         Japan           AI 2002-353170         12/6/2002         Japan           AJ WO 02/51217         6/27/2002         WO           AK 0 981 156         7/14/2004         EP           AL         AM	DOCUMENT NUMBER         DATE         COUNTRY         CLASS SUBCLASS           AH 2003-007648         1/10/2003         Japan           AI 2002-353170         12/6/2002         Japan           AJ WO 02/51217         6/27/2002         WO           AK 0 981 156         7/14/2004         EP           AL         AM	DOCUMENT   NUMBER   AH   2003-007648   1/10/2003   Japan   Japan   X		

OTHER INFORMATION (Including Author, Title, Date, Pertinent Pages, Etc.)

AP Australian Patent Office Search Report (mailed December 9, 2005) via IPOS (Singapore)

AQ Australian Patent Office Written Opinion (mailed December 9, 2005) via IPOS (Singapore)

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EXAMINER: DATE CONSIDERED:

\*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.